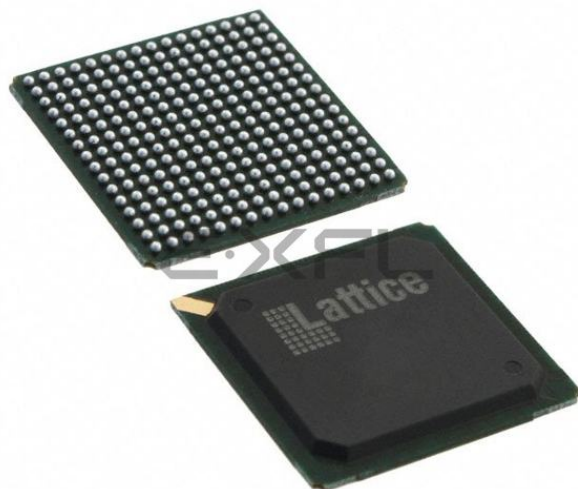




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	4250
Number of Logic Elements/Cells	34000
Total RAM Bits	2151424
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m35se-6f256i

Features

■ High Logic Density for System Integration

- 6K to 95K LUTs
- 90 to 583 I/Os

■ Embedded SERDES (LatticeECP2M Only)

- Data Rates 250 Mbps to 3.125 Gbps
- Up to 16 channels per device
PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.

■ sysDSP™ Block

- 3 to 42 blocks for high performance multiply and accumulate
- Each block supports
 - One 36x36, four 18x18 or eight 9x9 multipliers

■ Flexible Memory Resources

- 55Kbits to 5308Kbits sysMEM™ Embedded Block RAM (EBR)
 - 18Kbit block
 - Single, pseudo dual and true dual port
 - Byte Enable Mode support
- 12K to 202Kbits distributed RAM
 - Single port and pseudo dual port

■ sysCLOCK Analog PLLs and DLLs

- Two GPLLs and up to six SPLLs per device
 - Clock multiply, divide, phase & delay adjust
 - Dynamic PLL adjustment
- Two general purpose DLLs per device

■ Pre-Engineered Source Synchronous I/O

- DDR registers in I/O cells
- Dedicated gearing logic
- Source synchronous standards support
 - SPI4.2, SFI4 (DDR Mode), XGMII
 - High Speed ADC/DAC devices
- Dedicated DDR and DDR2 memory support
 - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
- Dedicated DQS support

■ Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces

- LVTTTL and LVCMOS 33/25/18/15/12
- SSTL 3/2/18 I, II
- HSTL15 I and HSTL18 I, II
- PCI and Differential HSTL, SSTL
- LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL

■ Flexible Device Configuration

- 1149.1 Boundary Scan compliant
- Dedicated bank for configuration I/Os
- SPI boot flash interface
- Dual boot images supported
- TransFR™ I/O for simple field updates
- Soft Error Detect macro embedded

■ Optional Bitstream Encryption (LatticeECP2/M “S” Versions Only)

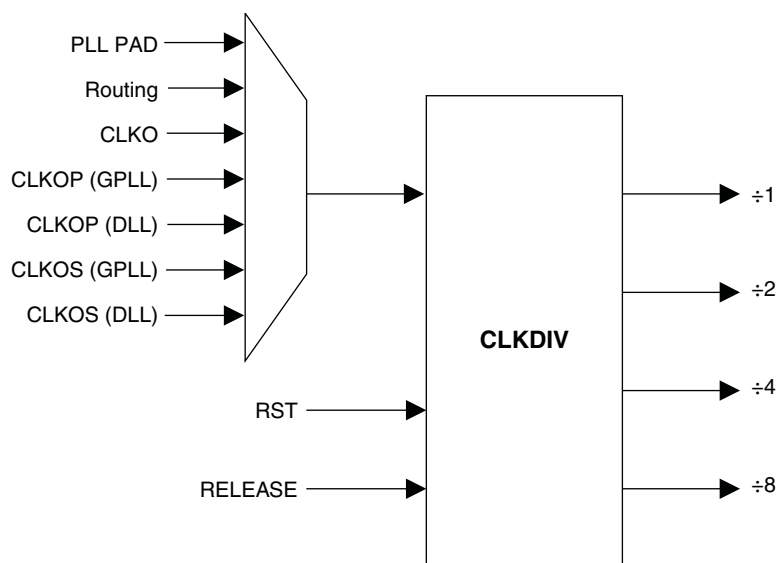
■ System Level Support

- ispTRACY™ internal logic analyzer capability
- On-chip oscillator for initialization & general use
- 1.2V power supply

Table 1-1. LatticeECP2 (Including “S-Series”) Family Selection

Device	ECP2-6	ECP2-12	ECP2-20	ECP2-35	ECP2-50	ECP2-70
LUTs (K)	6	12	21	32	48	68
Distributed RAM (Kbits)	12	24	42	64	96	136
EBR SRAM (Kbits)	55	221	276	332	387	1032
EBR SRAM Blocks	3	12	15	18	21	60
sysDSP Blocks	3	6	7	8	18	22
18x18 Multipliers	12	24	28	32	72	88
GPLL + SPLL + DLL	2+0+2	2+0+2	2+0+2	2+0+2	2+2+2	2+4+2
Maximum Available I/O	190	297	402	450	500	583
Packages and I/O Combinations						
144-pin TQFP (20 x 20 mm)	90	93				
208-pin PQFP (28 x 28 mm)		131	131			
256-ball fpBGA (17 x 17 mm)	190	193	193			
484-ball fpBGA (23 x 23 mm)		297	331	331	339	
672-ball fpBGA (27 x 27 mm)			402	450	500	500
900-ball fpBGA (31 x 31 mm)						583

Figure 2-9. Clock Divider Connections



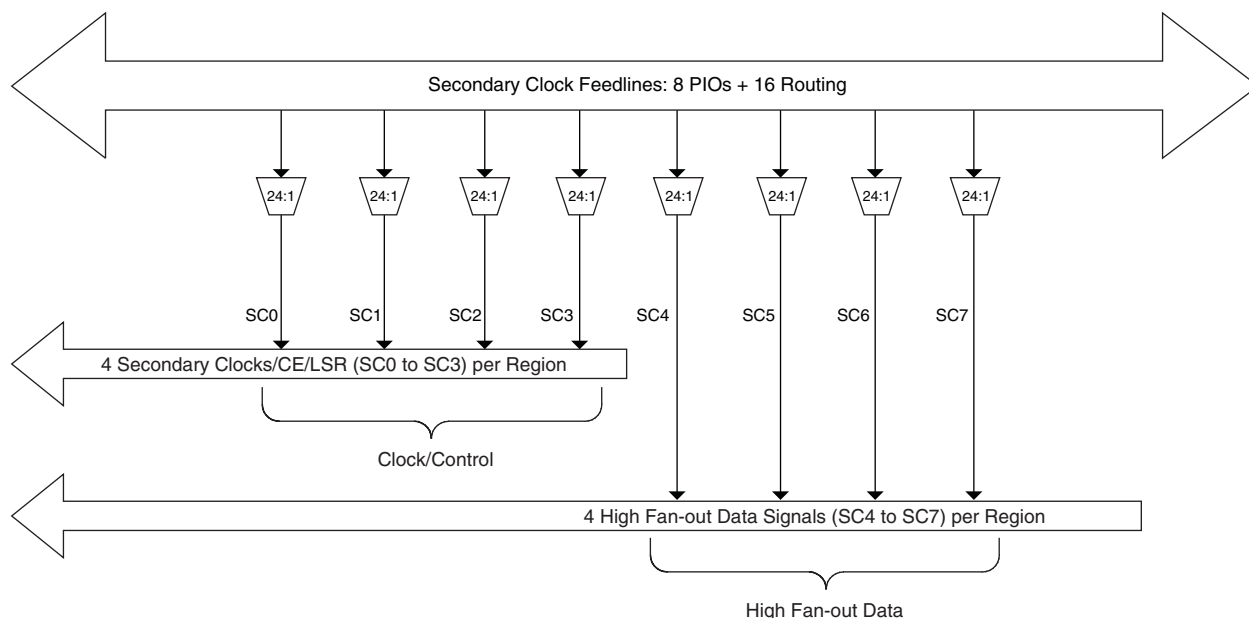
Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLK-DIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

Figure 2-16. Secondary Clock Selection

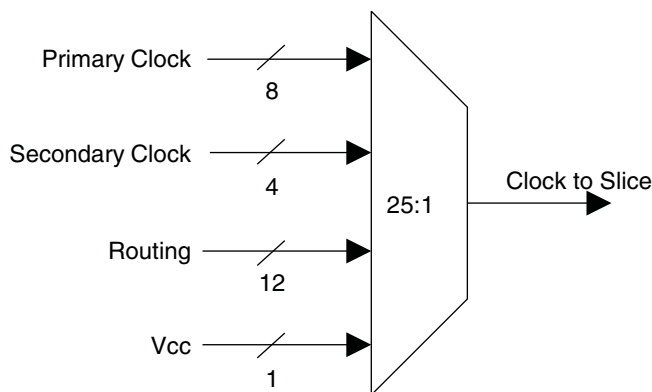


Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

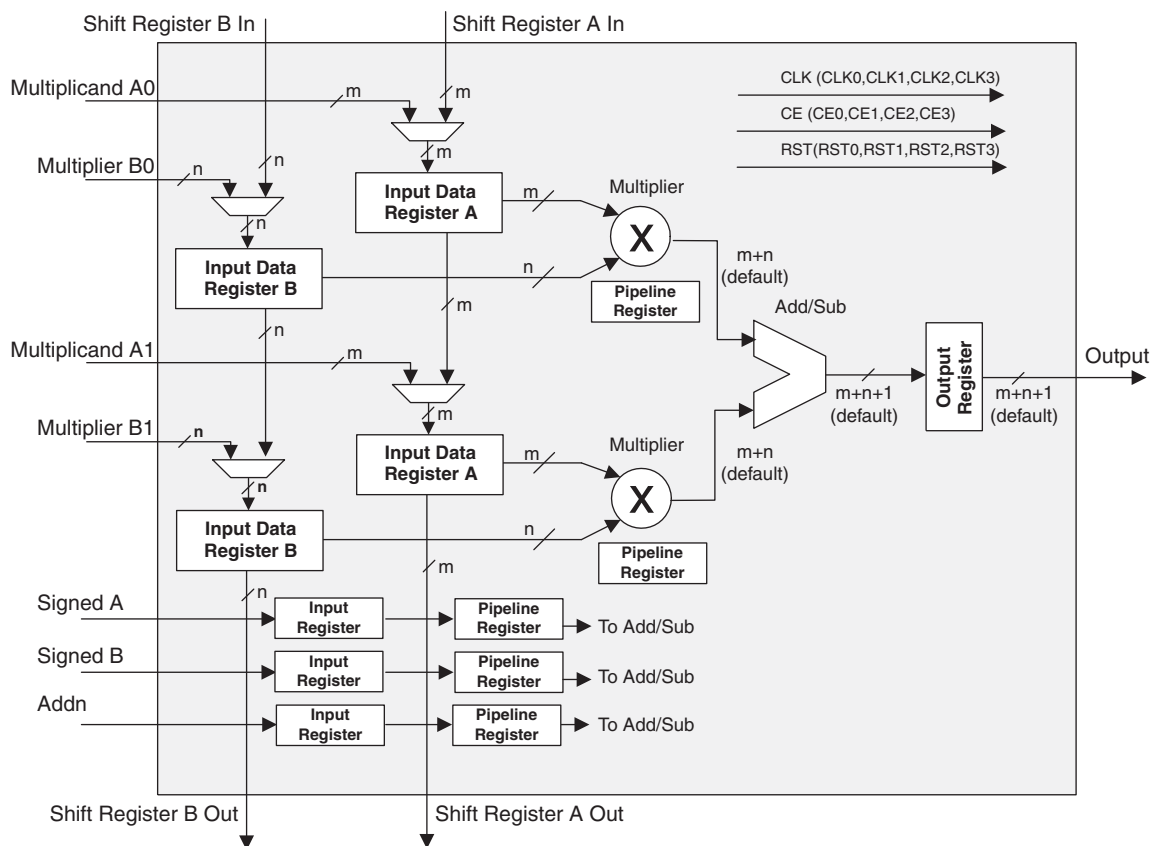
Figure 2-17. Slice0 through Slice2 Clock Selection



MULTADDSUB sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-25 shows the MULTADDSUB sysDSP element.

Figure 2-25. MULTADDSUB



Top Edge

The PICs on the top edge are different from PIOs on the left, right and bottom edges. PIOs on this edge do not have DDR registers or DQS signals.

The exact DQS pins are shown in a dual function in the Logic Signal Connections table in this data sheet. Additional detail is provided in the Signal Descriptions table. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. Interfaces on the left and right edges are designed for DDR memories that support 16 bits of data, whereas interfaces on the bottom are designed for memories that support 18 bits of data.

Figure 2-33. DQS Input Routing for the Left and Right Edges of the Device

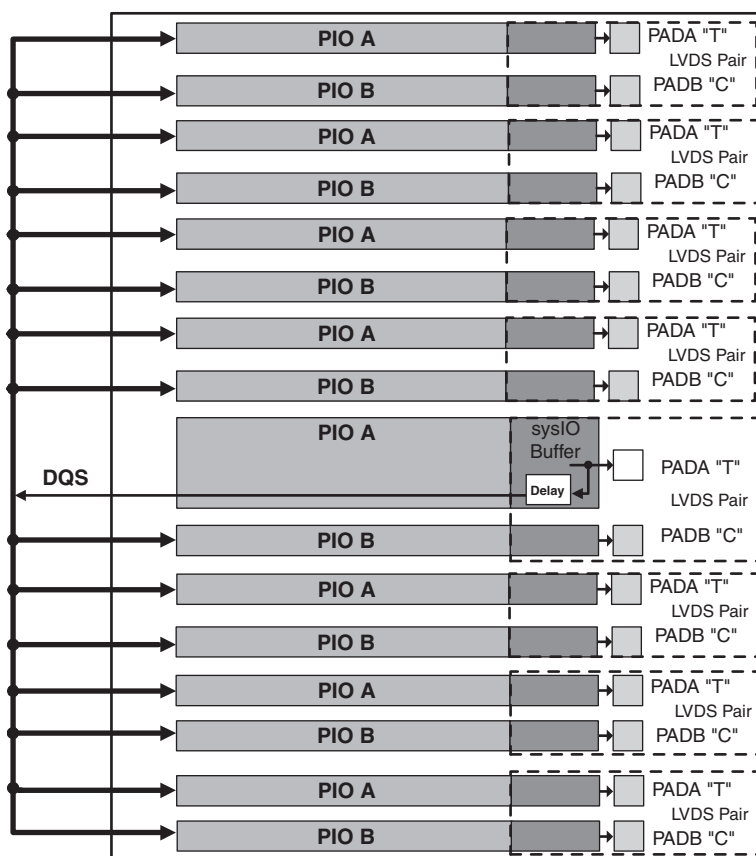
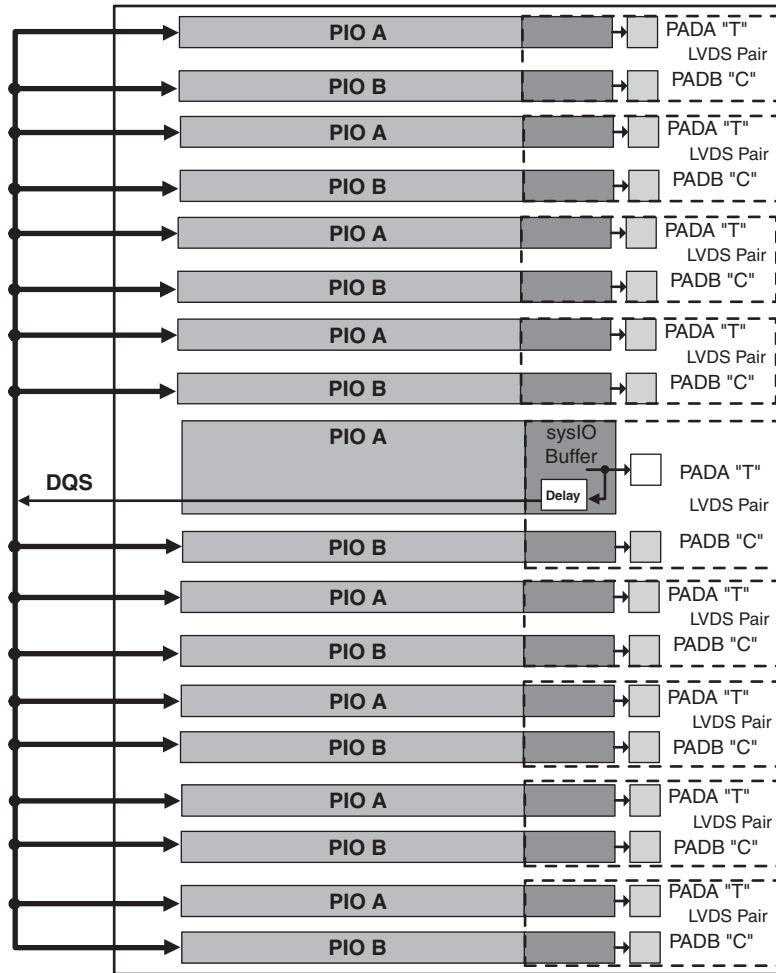


Figure 2-34. DQS Input Routing for the Bottom Edge of the Device



DLL Calibrated DQS Delay Block

Source synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However, in DDR memories the clock (referred to as DQS) is not free-running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only, as shown in Figure 2-35) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figure 2-35 and Figure 2-36 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two dedicated DLLs (DDR_DLL) on opposite sides of the device. Each DLL compensates DQS delays in its half of the device as shown in Figure 2-35. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

sys/I/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35 V_{CC}$	$0.65 V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3 V_{CCIO}$	$0.5 V_{CCIO}$	3.6	$0.1 V_{CCIO}$	$0.9 V_{CCIO}$	1.5	-0.5
SSTL3 Class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 Class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 Class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
SSTL18 Class II	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.28	$V_{CCIO} - 0.28$	8	-8
							11	-11
HSTL Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	4	-4
							8	-8
HSTL18 Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
							12	-12
HSTL18 Class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{SU_DEL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.40	—	1.70	—	1.90	—	ns
		LFE2M70	1.40	—	1.70	—	1.90	—	ns
		LFE2M100	1.40	—	1.70	—	1.90	—	ns
t _{H_DEL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IO}	Clock Frequency of I/O Register and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Edge Clock without PLL)¹									
t _{COE}	Clock to Output - PIO Output Register	LFE2-6	—	2.60	—	2.90	—	3.20	ns
		LFE2-12	—	2.60	—	2.90	—	3.20	ns
		LFE2-20	—	2.60	—	2.90	—	3.20	ns
		LFE2-35	—	2.60	—	2.90	—	3.20	ns
		LFE2-50	—	2.60	—	2.90	—	3.20	ns
		LFE2-70	—	2.60	—	2.90	—	3.20	ns
		LFE2M20	—	2.60	—	2.90	—	3.20	ns
		LFE2M35	—	2.60	—	2.90	—	3.20	ns
		LFE2M50	—	3.10	—	3.40	—	3.70	ns
		LFE2M70	—	3.10	—	3.40	—	3.70	ns
		LFE2M100	—	3.10	—	3.40	—	3.70	ns

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f _{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	20	—	420	MHz
		With external capacitor ^{5, 6}	2	—	420	MHz
f _{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	20	—	420	MHz
		With external capacitor ⁵	5	—	50	MHz
f _{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.156	—	210	MHz
		With external capacitor ⁵	0.039	—	25	MHz
f _{VCO}	PLL VCO Frequency		640	—	1280	MHz
f _{PFD}	Phase Detector Input Frequency	Without external capacitor	20	—	420	MHz
		With external capacitor ^{5, 6}	2	—	50	MHz
AC Characteristics						
t _{DT}	Output Clock Duty Cycle	Default duty cycle selected ³	45	50	55	%
t _{PH} ⁴	Output Phase Accuracy		—	—	±0.05	UI
t _{OPJIT} ¹	Output Clock Period Jitter	f _{OUT} ≥ 100 MHz	—	—	±125	ps
		50 ≤ f _{OUT} < 100 MHz	—	—	0.025	UIPP
		f _{OUT} < 50 MHz	—	—	0.04	UIPP
t _{SK}	Input Clock to Output Clock Skew	N/M = integer	—	—	±250	ps
t _W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t _{LOCK} ²	PLL Lock-in Time	Without external capacitor	—	—	150	μs
		With external capacitor ⁵	—	—	500	μs
t _{PA}	Programmable Delay Unit		85	130	360	ps
t _{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t _{FBKDLY}	External Feedback Delay		—	—	10	ns
t _{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t _{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t _{RST}	RST Pulse Width (RESETM/RESETK)		15	—	—	ns
	Reset Signal Pulse Width (CNTRST)	Without external capacitor	500	—	—	ns
		With external capacitor ⁵	20	—	—	μs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Relative to CLKOP.

5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.

6. $f_{OUT} (max) = f_{IN} * 10$ for $f_{IN} < 5$ MHz.

SERDES External Reference Clock (LatticeECP2M Family Only)

The external reference clock selection and its interface are a critical part of system applications for this product. Table 3-14 specifies reference clock requirements, over the full range of operating conditions.

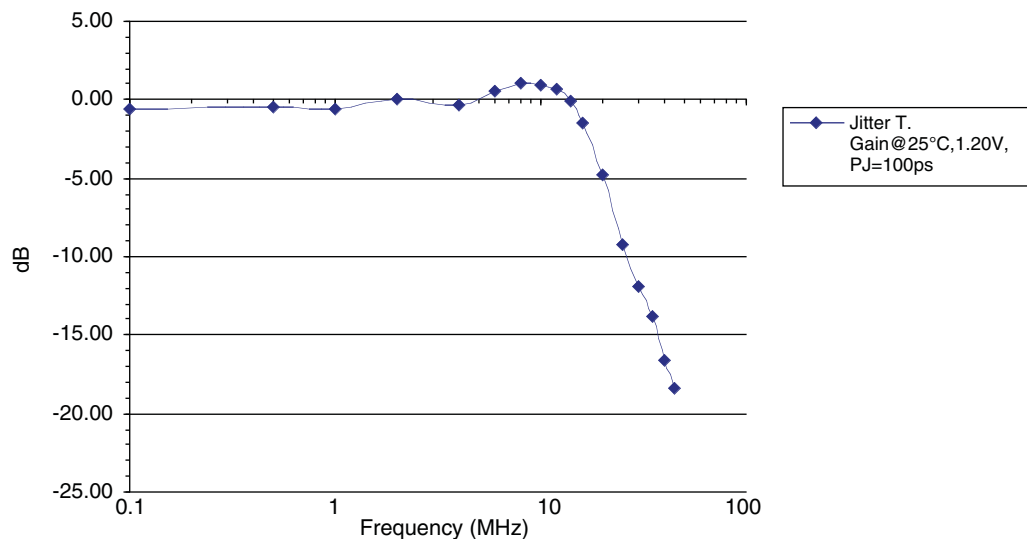
Table 3-14. External Reference Clock Specification (refclkp/refclkn)

Symbol	Description	Min.	Typ.	Max.	Units
F _{REF}	Frequency range	25	—	320	MHz
F _{REF-PPM}	Frequency tolerance	-300	—	300	ppm
V _{REF-IN-SE}	Input swing, single-ended clock ¹	100	—	1200	mV, p-p
V _{REF-IN}	Input levels	0	—	V _{CCP} + 0.8	V
V _{REF-CM-DC}	Input common mode range (DC coupled)	0.5	—	1.2	V
V _{REF-CM-AC}	Input common mode range (AC coupled) ²	0	—	1.5	V
D _{REF}	Duty cycle ³	40	—	60	%
T _{REF-R}	Rise time (20% to 80%)		500	1000	ps
T _{REF-F}	Fall time (80% to 20%)		500	1000	ps
Z _{REF-IN-TERM}	Input termination		50/2K		Ohms
C _{REF-IN-CAP}	Input capacitance ⁴	—	—	1.5	pF

1. The signal swing for a single-ended input clock must be as large as the p-p differential swing of a differential input clock to get the same gain at the input receiver. Lower swings for the clock may be possible, but will tend to increase jitter.
2. When AC coupled, the input common mode range is determined by:

$$(\text{Min input level}) + (\text{Peak-to-peak input swing})/2 \leq (\text{Input common mode voltage}) \leq (\text{Max input level}) - (\text{Peak-to-peak input swing})/2$$
3. Measured at 50% amplitude.
4. Input capacitance of 1.5pF is total capacitance, including both device and package.

Figure 3-13. Jitter Transfer



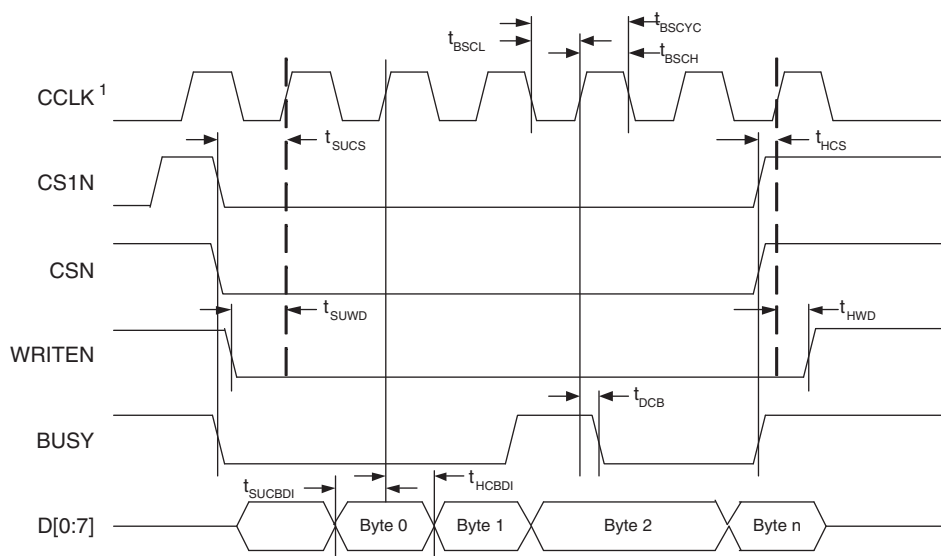
Note: This graph is for a nominal device.

SERDES Power-Down/Power-Up Specification

Table 3-15. Power-Down and Power-Up Specification

Symbol	Description	Max.	Units
t _{PWRDN}	Power-down time after all power down register bits set to '0'	10	μs
t _{PWRUP}	Power-up time after all power down register bits set to '1'	100	μs

Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

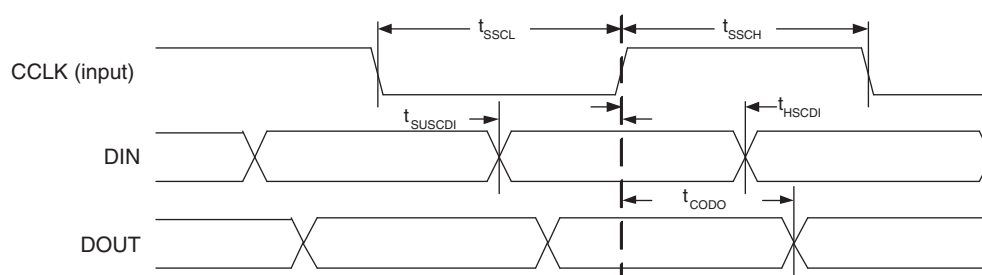
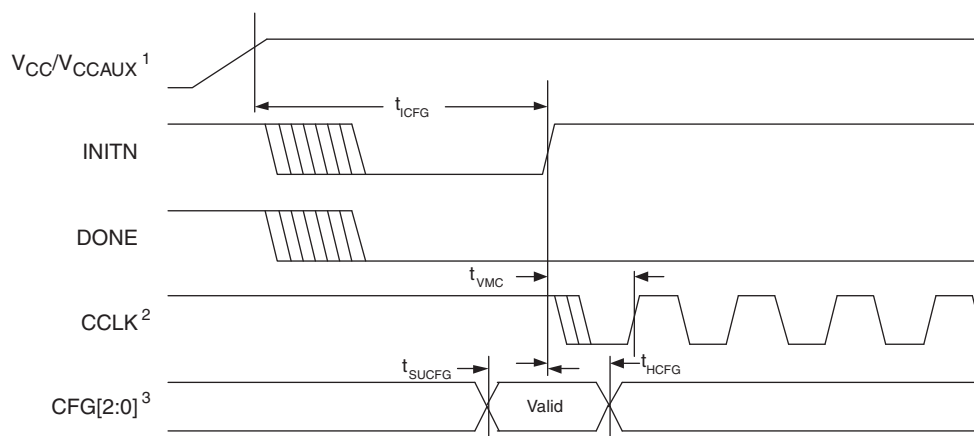


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX} , whichever is the last to reach its V_{MIN} .
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V _{CC}	LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V _{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V _{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V _{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V _{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V _{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V _{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V _{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V _{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V _{CCIO8}	AC24, U17	AA25, AD28
V _{CCJ}	AA7	AG1
V _{CCAUX}	LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V _{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power ³	LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C3	C3	PL2A	7	VREF2_7	T (LVDS)*
C2	C2	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO	VCCIO7	7		
-	GND	GNDIO7	7		
D3	D3	PL7A	7	LDQ8	T
D4	D4	PL6A	7	LDQ8	T (LVDS)*
D2	D2	PL7B	7	LDQ8	C
GND	GND	GNDIO7	-		
E4	E4	PL6B	7	LDQ8	C (LVDS)*
B1	B1	PL13A	7	LDQ16	T
C1	C1	PL13B	7	LDQ16	C
F5	F5	PL15A	7	LDQ16	T
VCCIO	VCC	VCCIO	7		
F4	F4	PL14A	7	LDQ16	T (LVDS)*
G6	G6	PL15B	7	LDQ16	C
G4	G4	PL14B	7	LDQ16	C (LVDS)*
D1	D1	PL16A	7	LDQS16	T (LVDS)*
GND	GND	GNDIO7	-		
E1	E1	PL16B	7	LDQ16	C (LVDS)*
F3	F3	PL17A	7	LDQ16	T
G3	G3	PL17B	7	LDQ16	C
VCCIO	VCCIO	VCCIO7	7		
F2	F2	PL18A	7	LDQ16	T (LVDS)*
F1	F1	PL18B	7	LDQ16	C (LVDS)*
GND	GND	GNDIO7	-		
G2	G2	PL19A	7	PCLKT7_0/LDQ16	T
G1	G1	PL19B	7	PCLKC7_0/LDQ16	C
H6	H6	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO	VCCIO6	6		
H5	H5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
H4	H4	PL22A	6	VREF2_6/LDQ25	T
GND	GND	GNDIO6	-		
H3	H3	PL22B	6	VREF1_6/LDQ25	C
H2	H2	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
H1	H1	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
G10	G10	VCC	-		
J4	J4	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
J5	J5	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
J6	J6	LLM0_PLLCAP	6		
K4	K4	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GND	GND	GNDIO6	-		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N16	VCCIO3	3			VCCIO3	3		
P16	VCCIO3	3			VCCIO3	3		
R14	VCCIO4	4			VCCIO4	4		
T12	VCCIO4	4			VCCIO4	4		
T13	VCCIO4	4			VCCIO4	4		
T14	VCCIO4	4			VCCIO4	4		
R9	VCCIO5	5			VCCIO5	5		
T10	VCCIO5	5			VCCIO5	5		
T11	VCCIO5	5			VCCIO5	5		
T9	VCCIO5	5			VCCIO5	5		
N7	VCCIO6	6			VCCIO6	6		
P7	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		
R8	VCCIO6	6			VCCIO6	6		
J8	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
L7	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
P15	VCCIO8	8			VCCIO8	8		
R15	VCCIO8	8			VCCIO8	8		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
C14	GND	-			GND	-		
C9	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
F17	GND	-			GND	-		
F6	GND	-			GND	-		
H10	GND	-			GND	-		
H11	GND	-			GND	-		
H12	GND	-			GND	-		
H13	GND	-			GND	-		
J14	GND	-			GND	-		
J20	GND	-			GND	-		
J3	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K12	GND	-			GND	-		
K13	GND	-			GND	-		
K15	GND	-			GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A12	PT35B	0		C	PT44B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
A11	PT35A	0		T	PT44A	0		T	
D12	PT34B	0		C	PT43B	0		C	
H16	PT34A	0		T	PT43A	0		T	
H18	PT33B	0		C	PT42B	0		C	
H15	PT33A	0		T	PT42A	0		T	
A10	PT32B	0		C	PT41B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
B10	PT32A	0		T	PT41A	0		T	
D11	PT31B	0		C	PT40B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
G14	PT31A	0		T	PT40A	0		T	
E11	PT30B	0		C	PT39B	0		C	
F13	PT30A	0		T	PT39A	0		T	
D10	PT29B	0		C	PT38B	0		C	
H14	PT29A	0		T	PT38A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
A9	PT24B	0		C	PT24B	0		C	
C10	PT23B	0		C	PT23B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
E8	PT23A	0		T	PT23A	0		T	
B9	PT22B	0		C	PT22B	0		C	
A8	PT22A	0		T	PT22A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F12	PT21B	0		C	PT21B	0		C	
E10	PT21A	0		T	PT21A	0		T	
G13	PT20B	0		C	PT20B	0		C	
C9	PT20A	0		T	PT20A	0		T	
B8	PT19B	0		C	PT19B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
A7	PT19A	0		T	PT19A	0		T	
D9	PT18B	0		C	PT18B	0		C	
H13	PT18A	0		T	PT18A	0		T	
D6	PT17B	0		C	PT17B	0		C	
C7	PT17A	0		T	PT17A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
C8	PT16B	0		C	PT16B	0		C	
G12	PT16A	0		T	PT16A	0		T	
D8	PT15B	0		C	PT15B	0		C	
H12	PT15A	0		T	PT15A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
A6	PT14B	0		C	PT14B	0		C	
A5	PT14A	0		T	PT14A	0		T	
A4	PT13B	0		C	PT13B	0		C	
A3	PT13A	0		T	PT13A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T	
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C	
GNDIO	GNDIO7	-			GNDIO7	-			
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
GNDIO	GNDIO7	-			-	-			
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
E2	PL14A	7		T	PL14A	7	LDQ15	T	
D1	PL14B	7		C	PL14B	7	LDQ15	C	
-	-	-			GNDIO7	-			
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*	
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*	
K7	NC	-			PL16A	7	LDQ15	T	
K8	NC	-			PL16B	7	LDQ15	C	
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*	
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*	
F1	NC	-			PL18A	7	LDQ15	T	
-	-	-			GNDIO7	-			
G3	NC	-			PL18B	7	LDQ15	C	
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*	
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*	
J5	PL16A	7		T	PL22A	7		T	
J4	PL16B	7		C	PL22B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*	
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*	
L9	NC	-			PL25A	7	LDQ28	T	
L7	NC	-			PL25B	7	LDQ28	C	
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*	
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*	
L8	NC	-			PL27A	7	LDQ28	T	
L6	NC	-			PL27B	7	LDQ28	C	
-	-	-			GNDIO7	-			
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*	
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*	
N8	PL19A	7		T	PL29A	7	LDQ28	T	
M9	PL19B	7		C	PL29B	7	LDQ28	C	
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*	
VCCIO	VCCIO7	7			-	-			
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*	
H1	PL21A	7		T	PL31A	7	LDQ28	T	
GNDIO	GNDIO7	-			GNDIO7	-			
J1	PL21B	7		C	PL31B	7	LDQ28	C	
-	-	-			-	-			
-	-	-			-	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J2	PL34B	7	LDQ32	C (LVDS)*
H1	PL35A	7	LDQ32	T
GNDIO	GNDIO7	-		
J1	PL35B	7	LDQ32	C
GNDIO	GNDIO7	-		
L5	PL41A	7	LDQ45	T (LVDS)*
L4	PL41B	7	LDQ45	C (LVDS)*
N9	PL42A	7	LDQ45	T
N7	PL42B	7	LDQ45	C
K2	PL43A	7	LDQ45	T (LVDS)*
K1	PL43B	7	LDQ45	C (LVDS)*
P9	PL44A	7	LDQ45	T
P7	PL44B	7	LDQ45	C
GNDIO	GNDIO7	-		
M6	PL45A	7	LDQS45	T (LVDS)*
M5	PL45B	7	LDQ45	C (LVDS)*
N5	PL46A	7	LDQ45	T
N6	PL46B	7	LDQ45	C
M4	PL47A	7	LDQ45	T (LVDS)*
M3	PL47B	7	LDQ45	C (LVDS)*
P6	PL48A	7	LDQ45	T
GNDIO	GNDIO7	-		
P8	PL48B	7	LDQ45	C
L3	PL50A	7	LUM3_SPLLT_IN_A/LDQ54	T (LVDS)*
L2	PL50B	7	LUM3_SPLLC_IN_A/LDQ54	C (LVDS)*
P5	PL51A	7	LUM3_SPLLT_FB_A/LDQ54	T
P4	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
L1	PL52A	7	LDQ54	T (LVDS)*
M2	PL52B	7	LDQ54	C (LVDS)*
R5	PL53A	7	LDQ54	T
R4	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-		
M1	PL54A	7	LDQS54	T (LVDS)*
N2	PL54B	7	LDQ54	C (LVDS)*
R8	PL55A	7	LDQ54	T
T9	PL55B	7	LDQ54	C
P3	PL56A	7	LDQ54	T (LVDS)*
P2	PL56B	7	LDQ54	C (LVDS)*
N1	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-		
P1	PL57B	7	PCLKC7_0/LDQ54	C
T5	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
T4	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U22	GND	-			GND	-		
U23	GND	-			GND	-		
V12	GND	-			GND	-		
V13	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V18	GND	-			GND	-		
V19	GND	-			GND	-		
V20	GND	-			GND	-		
V22	GND	-			GND	-		
V23	GND	-			GND	-		
W12	GND	-			GND	-		
W13	GND	-			GND	-		
W15	GND	-			GND	-		
W16	GND	-			GND	-		
W17	GND	-			GND	-		
W18	GND	-			GND	-		
W19	GND	-			GND	-		
W20	GND	-			GND	-		
W22	GND	-			GND	-		
W23	GND	-			GND	-		
W26	GND	-			GND	-		
W31	GND	-			GND	-		
W4	GND	-			GND	-		
W9	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
Y18	GND	-			GND	-		
Y19	GND	-			GND	-		
A11	NC	-			NC	-		
A12	NC	-			NC	-		
A23	NC	-			NC	-		
A24	NC	-			NC	-		
AA11	NC	-			NC	-		
AB11	NC	-			NC	-		
AC26	NC	-			NC	-		
AC30	NC	-			NC	-		
AD11	NC	-			NC	-		
AD12	NC	-			NC	-		
AD13	NC	-			NC	-		
AD14	NC	-			NC	-		
AD15	NC	-			NC	-		
AD19	NC	-			NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD23	NC	-			NC	-		
AE10	NC	-			NC	-		
AE11	NC	-			NC	-		